



3.5x2.8mm PLCC4 SMD LED

 $\begin{array}{c} TNI \\ 3 & \longrightarrow \searrow \longrightarrow 4 \end{array}$ 

 $\begin{array}{c} \text{Red} \\ \text{2} & \longrightarrow \text{1} \end{array}$ 

#### **Features**

• Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 2000pcs/ Reel

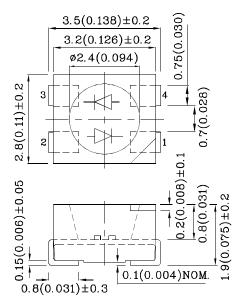
• MSL (Moisture Sensitivity Level): 3

• RoHS compliant.





## Package Schematics



## Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings ( $T_A=25^{\circ}C$ )		Red (AlGaInP)	Unit		
Reverse Voltage	$V_{\mathrm{R}}$	5	V		
Forward Current	$I_{\mathrm{F}}$	50	mA		
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\mathrm{FS}}$	150	mA		
Power Dissipation	$P_{D}$	125	mW		
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +85	C		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)	Red (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.1	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λΡ	660*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	640*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (Po =mW/sr) @20mA		Luminous Intensity CIE127-2007* (IF=20mA) mcd		Wavelength CIE127-2007* nm λ P	Viewing Angle 2 0 1/2
				min.	typ.	min.	typ.		
W/ZMOMDENII AE CCOC	Red	AlGaInP	Water Clear —	-	-	400 120*	597 228*	660*	1000
XZM2MRTNI45SC2C ——	-	GaAs		2 1.2*	3.8 2.3*	-	-	940*	120°

<sup>\*</sup>Luminous/Radiant intensity value and wavelength are in accordance with CIE127-2007 standards. Aug 29,2016

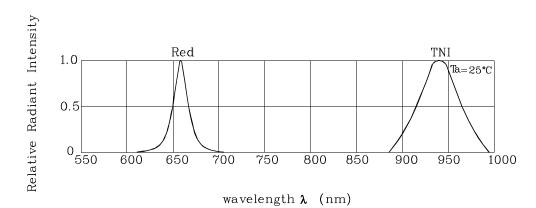
## Part Number: XZM2MRTNI45SC2C

3.5x2.8mm PLCC4 SMD LED

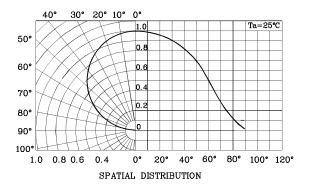
Absolute Maximum Ratings (T <sub>A</sub> =25°C)		TNI (GaAs)	Unit	Operating Characteristics (T <sub>A</sub> =25°C)	TNI (GaAs)
Reverse Voltage	$V_{\rm R}$	5	V	Forward Voltage (Typ.) (I=20mA)  V <sub>F</sub>	1.5
Forward Current	$I_{\mathrm{F}}$	50	mA	(IF-20IIA)	<u> </u>
Forward Current (Peak) 1/100 Duty Cycle	$i_{\mathrm{FS}}$	1200	mA	Forward Voltage (Max.) $V_{\rm F}$ (I <sub>F</sub> =20mA)	1.0
10us Pulse Width	142	1200	1112.1	Reverse Current (Max.)	10
Power Dissipation	$P_{\mathrm{D}}$	80	mW	$(V_R=5V)$	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	Wavelength of Peak Emission CIE127-2007* (Typ.) λP	940
Storage Temperature	Tstg	-40 ~ +85		(I <sub>F</sub> =20mA)	

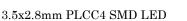
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)	TNI (GaAs)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.6	V
Reverse Current (Max.) $(V_R=5V)$	${ m I}_{ m R}$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λΡ	940*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	50	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	90	pF



RELATIVE INTENSITY Vs. CIE WAVELENGTH

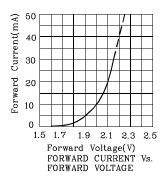


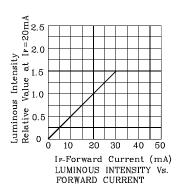


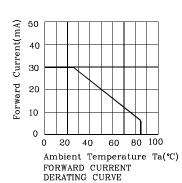


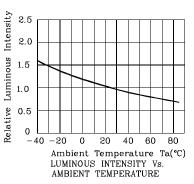


### \* Red

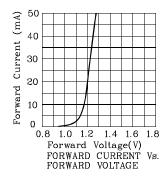


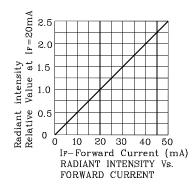


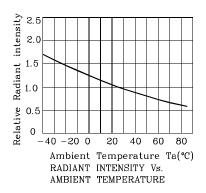




## **❖** TNI

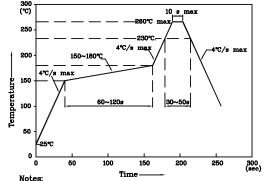






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

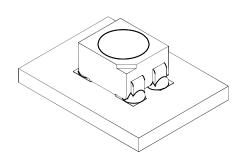


- notes:
  1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

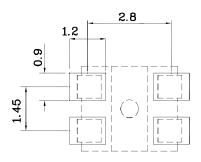




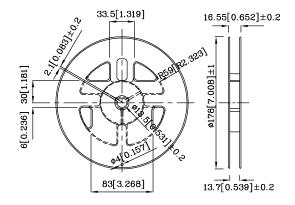
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



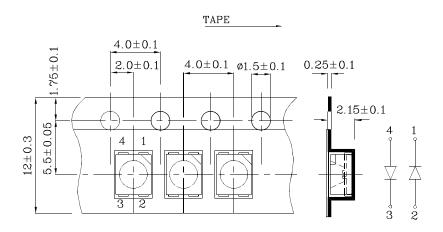
**♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



## **❖** Reel Dimension



## **❖** Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

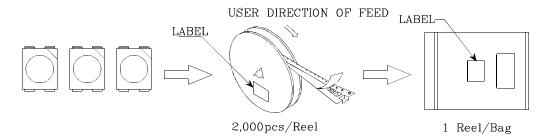
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

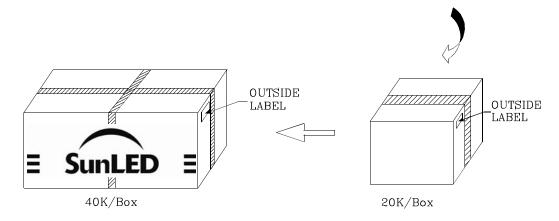
Note: Accuracy may depend on the sorting parameters.

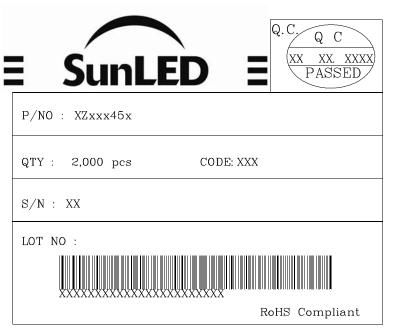




## PACKING & LABEL SPECIFICATIONS







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